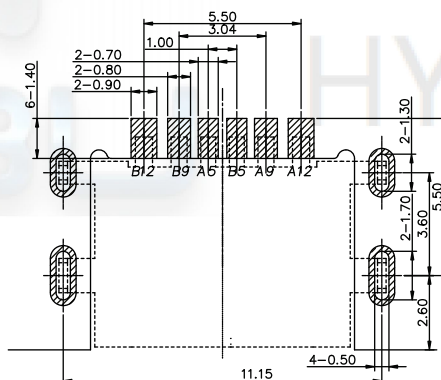
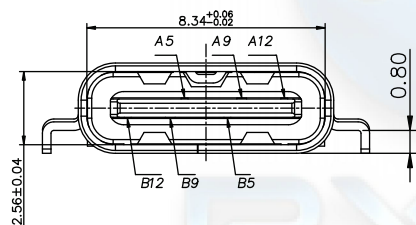
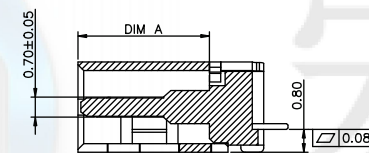
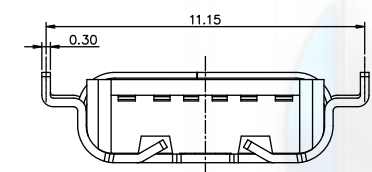
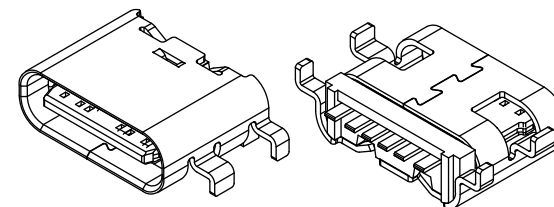
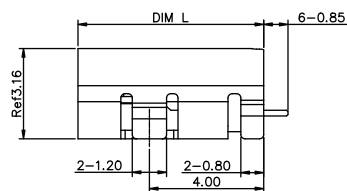
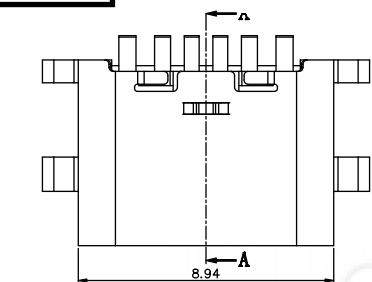


ROHS
Compatible



RECOMMEND P.C.B LAYOUT (COMPONENT SIDE)
TOLERANCE FOR PCB LAYOUT IS ± 0.05

NOTE:

- MATERIAL SPECIFICATION:
 - HOUSING: HIGH TEMPERATURE RESISTANT PLASTIC, UL94 V-0.
 - CONTACTS: COPPER ALLOY
 - MID PLATE: STAINLESS STEEL
- PLATING SPECIFICATION:
 - CONTACTS:
Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
(GOLD PLATING THICKNESS FOLLOW THE P/N)
GOLD FLASH PLATING ON SOLDER AREA
 - FRONT SHELL:
Ni 30u" MIN. UNDER PLATED OVER ALL.
- MECHANICAL PERFORMANCE,
 - INSERTION FORCE: 0.5~2.0kgf.
 - REMOVAL FORCE: 0.8kgf~2.0kgf.
 - DURABILITY: 10000 CYCLES.
- ELECTRICAL PERFORMANCE,
 - CURRENT RATING: 5.0A
VOLTAGE RATING: 20V
 - INSULATION RESISTANCE: 100MΩ MIN
 - DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.
- ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -30℃~+80℃.
- IR REFLOW:
THE PEAK TEMPERATURE ON THE BOARD SHALL
BE MAINTAINED FOR 10 SECONDS AT 260℃.

U5 067- 06P x 0.8C XXL
↓ ↓ ↓ ↓ ↓ ↓
名称 流水号 PIN位 N;母座 C;沉板 L;长度

USB TYPE-C PIN ASSIGNMENTS

PIN NUMBER	SIGNAL NAME
A5	CC1
A9	VBUS
A12	GND
B12	GND
B9	VBUS
B5	CC2

DIM L	DIM A
6.80	4.90
6.50	4.60

DESIGN	Li Jinwei	SCALL	
DRAWING	Wu Qifa	UNIT	mm
CHECK	Zheng Jinxian	SIZE	A4: 210 * 297
APPROVAL	Liu Xiaohong	DATE	2020-06-10

TOLERANCE	
X.X ±0.30	X.° ±2°
.XX ±0.20	.X° ±1°
.XXX ±0.10	.XX° ±0.5°

DRAWG NO.	U5067-06PN0.8CXXL
TITLE:	6P 四脚插板SMT 沉板0.8mm

 **广东宏煜盛电子科技有限公司**
Guangdong Hongyusheng Electronic Technology Co., Ltd.
TEL: 0752-6632356 <https://www.hystypec.com>

